



N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Features

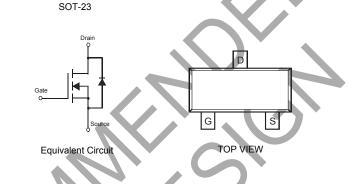
Low On-Resistance:

 $R_{DS(ON)} < 32m\Omega @ V_{GS} = 10V$ $R_{DS(ON)} < 42m\Omega @ V_{GS} = 4.5V$ $R_{DS(ON)} < 64m\Omega @ V_{GS} = 2.5V$

- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 2)
- "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.008 grams (approximate)



Maximum Ratings @T_A = 25°C unless otherwise specified

TOP VIEW

	Characteristic		Symbol	Value	Unit
Drain Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±12	V
Drain Current (Note 1)		T _A = 25°C T _A = 70°C	ID	5.4 4.6	A
Drain Current (Note 1)		Pulsed	I _{DM}	19	А
Body-Diode Continuous	Current (Note 1)		ls	2.0	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	PD	1.4	W
Thermal Resistance, Junction to Ambient $@T_A = 25^{\circ}C$ (Note 1)	$R_{ ext{ heta}JA}$	90	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Notes: 1. Device mounted on FR-4 PCB. t ≤5 sec.

2. No purposefully added lead.

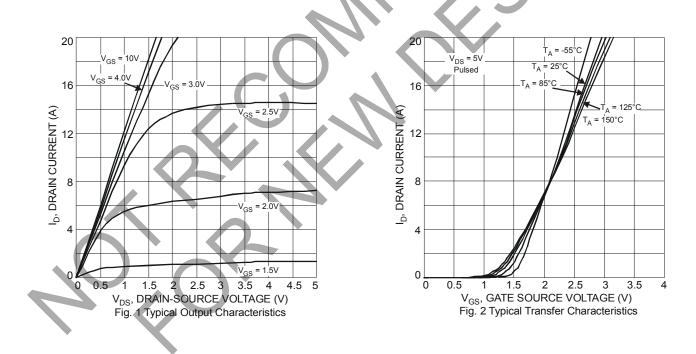
3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.



Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)						
Drain-Source Breakdown Voltage	BV _{DSS}	30		—	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current	I _{DSS}			1	μA	V _{DS} = 30V, V _{GS} = 0V
Gate-Body Leakage	I _{GSS}	_	_	±80 ±800	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$ $V_{GS} = \pm 19V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 4)						
Gate Threshold Voltage	V _{GS(th)}	0.62	0.9	1.2	V	V _{DS} = V _{GS} , I _D = 250μA
		_	26	32		V _{GS} = 10V, I _D = 5.8A
Static Drain-Source On-Resistance	Pro (ou)	_	33	42	mΩ	V _{GS} = 4.5V, I _D = 5.0A
	R _{DS (ON)}	—	52	64	11152	V _{GS} = 2.5V, I _D = 3.8A
		_	78	100		V_{GS} = 2.0V, I_{D} = 2.0A
Forward Transconductance	Y _{fs}		8		S	V _{DS} = 5V, I _D = 3.1A
Source-Drain Diode Forward Voltage	V _{SD}	_	0.75	1.2	V	V _{GS} = 0V, I _S = 2.0A
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{iss}	_	555	The second secon	pF	
Output Capacitance	Coss		109		pF	V _{DS} = 5V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	4	82	- (pF	
Total Gate Charge	Qg	\sim	6.3	-		
Gate-Source Charge			1.3		nC	$V_{GS} = 4.5V, V_{DS} = 15V,$
Gate-Drain Charge	Q _{gs} Q _{gd}		1.7			I _D = 5.8A

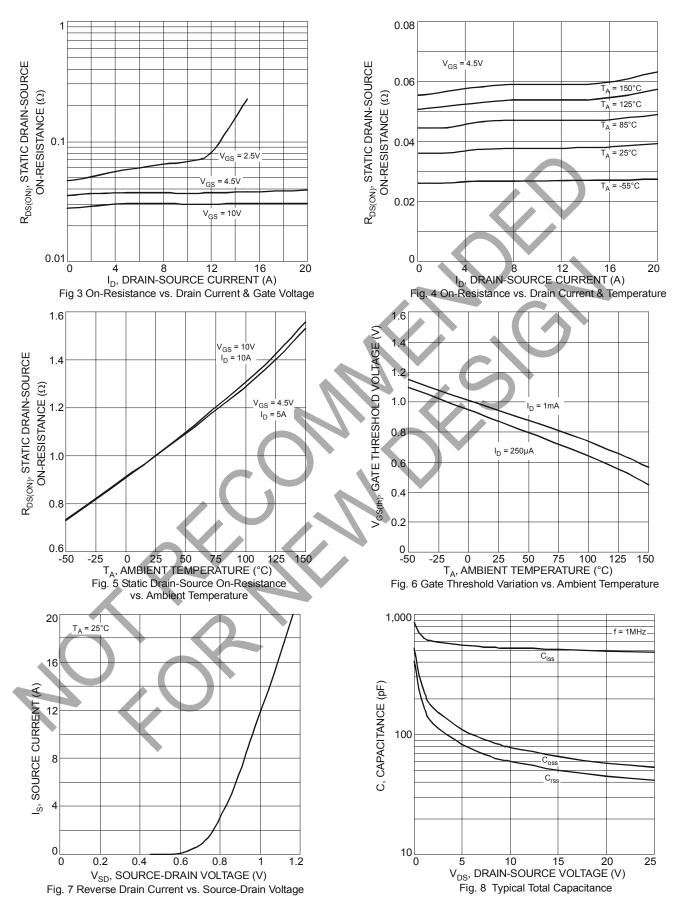
Notes: 4. Short duration pulse test used to minimize self-heating effect.

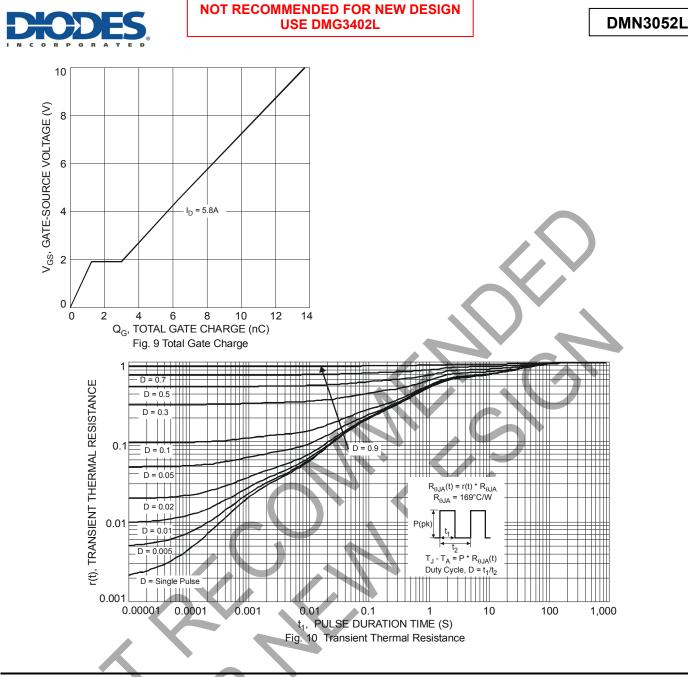




NOT RECOMMENDED FOR NEW DESIGN USE DMG3402L

DMN3052L



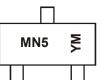


Ordering Information (Note 5)

Part Number	Case	Packaging
DMN3052L-7	SOT-23	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



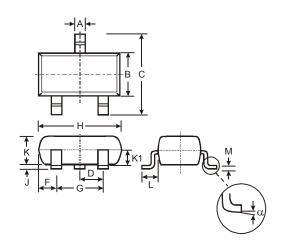
MN5 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: V = 2008) M = Month (ex: 9 = September)

Date	Code	Kev
Duic	oouc	1.09

Year	2008		2009	2010		2011	2012		2013	2014		2015
Code	V		W	Х		Y	Z		А	В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

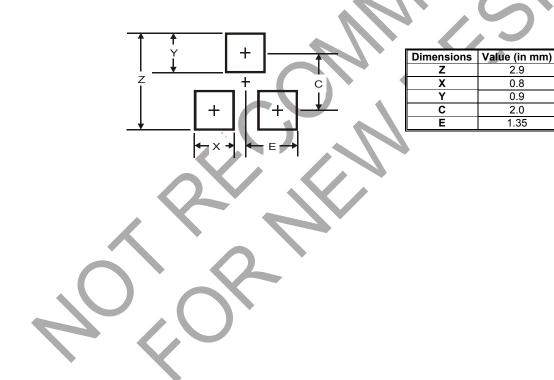


Package Outline Dimensions



SOT-23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
κ	0.903	1.10	1.00		
K1	-	- (0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All	Dimens	ions in	mm		
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Suggested Pad Layout





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